## MOSFET - Power, Single N-Channel, WDFN6 25 V, 4.1 mΩ, 19.4 A

# Product Preview NTLJS4D7N03H

## Features

- Small Footprint (4 mm<sup>2</sup>) for Compact Design
- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen-Free/BFR-Free and are RoHS Compliant

## Applications

- DC-DC Converters
- Wireless Chargers
- Power Load Switch
- Power Management and Protection
- Battery Management

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

| Paran   | neter                                 |                       | Symbol                                   | Value | Unit |
|---|---------------------------------------|-----------------------|--|-------|------|
| Drain-to-Source Voltag  | e                                     |                       | V <sub>DSS</sub>                         | 25    | V    |
| Gate-to-Source Voltage  | 9                                     |                       | V <sub>GS</sub>                          | ±20   | V    |
| Continuous Drain Cur-   | Steady                                | $T_A = 25^{\circ}C$   | I <sub>D</sub>                           | 19.4  | А    |
| rent R <sub>θJA</sub> (Notes 1, 3)                                | State                                 | T <sub>A</sub> = 85°C |  | 14    |      |
| Power Dissipation $R_{\theta JA}$ (Notes 1, 3)                    |                                       | $T_A = 25^{\circ}C$   | P <sub>D</sub>                           | 2.40  | W    |
| Continuous Drain Cur-   | Steady<br>State                       | $T_A = 25^{\circ}C$   | ۱ <sub>D</sub>                           | 11.6  | А    |
| rent $R_{\theta JA}$ (Notes 2, 3)                                 | Slale                                 | T <sub>A</sub> = 85°C |  | 8.4   |      |
| Power Dissipation $R_{\theta JA}$ (Notes 2, 3)                    |                                       | $T_A = 25^{\circ}C$   | P <sub>D</sub>                           | 0.86  | W    |
| Pulsed Drain Current  | $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ |                       | I <sub>DM</sub>                          | 78    | А    |
| Operating Junction and Range                                      | Storage T                             | emperature            | rature T <sub>J</sub> , T <sub>stg</sub> |       | °C   |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) |                                       | ΤL                    | 260                                      | °C    |      |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

| Parameter                                   | Symbol          | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Ambient - Steady State (Note 1) | $R_{\theta JA}$ | 52    | °C/W |
| Junction-to-Ambient - Steady State (Note 2) | $R_{\theta JA}$ | 145   |      |

1. Surface-mounted on FR4 board using 1 in<sup>2</sup> pad size, 2 oz. Cu pad.

- 2. Surface-mounted on FR4 board using minimum pad size, 2 oz. Cu pad.
- 3. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted. Actual continuous current will be limited by thermal & electro–mechanical application board design.  $R_{\theta CA}$  is determined by the user's board design.

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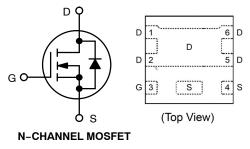


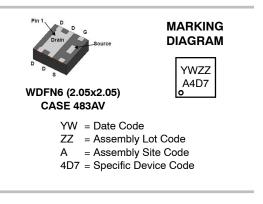
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| V <sub>(BR)DSS</sub> | R <sub>DS(on)</sub> MAX I <sub>D</sub> MA |        |
|----------------------|---|--------|
| 25 V                 | 4.1 mΩ @ 10 V                             | 19.4 A |
| 25 V                 | 6.25 mΩ @ 4.5 V                           | 19.4 A |

#### **ELECTRICAL CONNECTION**





## ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 4 of this data sheet.

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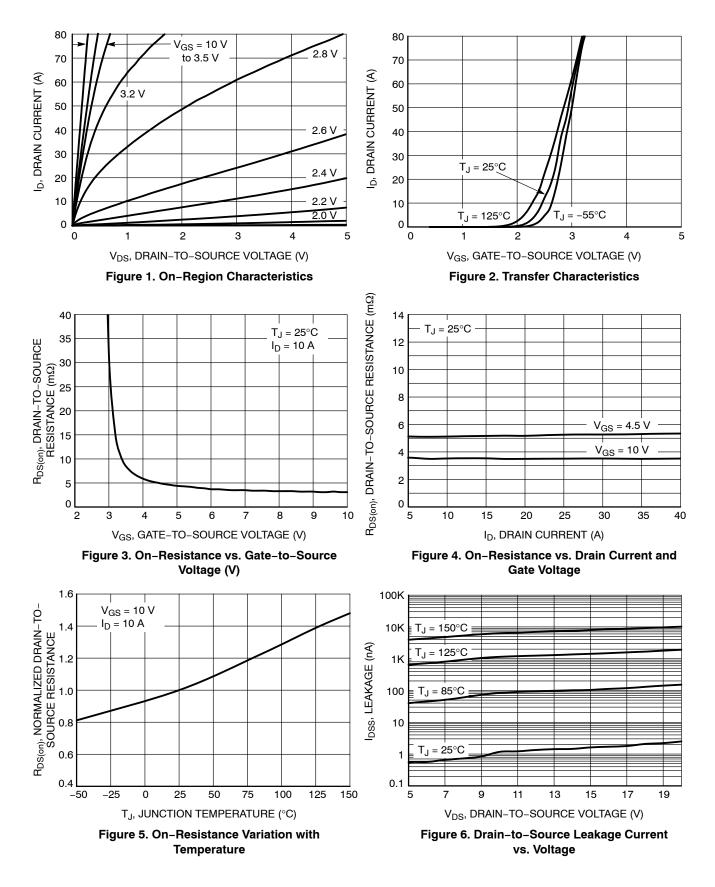
## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise noted)

| Parameter  | Symbol                                   | Test Condition   |                        | Min | Тур   | Max  | Unit  |
|--|--|--|------------------------|-----|-------|------|-------|
| OFF CHARACTERISTICS  | ·  |  |                        |     | -     | -    | -     |
| Drain-to-Source Breakdown Voltage                            | V <sub>(BR)DSS</sub>                     | $V_{GS}$ = 0 V, I <sub>D</sub> = 250 $\mu$ A   |                        | 25  |       |      | V     |
| Drain-to-Source Breakdown<br>Voltage Temperature Coefficient | V <sub>(BR)DSS</sub> /<br>T <sub>J</sub> | $I_D = 250 \ \mu\text{A}, \text{ ref to } 25^{\circ}\text{C}$  |                        |     | 16.2  |      | mV/°C |
| Zero Gate Voltage Drain Current                              | I <sub>DSS</sub>                         | V <sub>GS</sub> = 0 V,   | T <sub>J</sub> = 25°C  |     |       | 1    | μA    |
|  | $V_{\rm DS} = 20$ V                      | T <sub>J</sub> = 125°C   |                        |     | 10    | 1    |       |
| Gate-to-Source Leakage Current                               | I <sub>GSS</sub>                         | $V_{DS}$ = 0 V, $V_{GS}$   | = +20/-16 V            |     |       | ±100 | nA    |
| ON CHARACTERISTICS (Note 4)                                  |  |  |                        |     |       |      |       |
| Gate Threshold Voltage                                       | V <sub>GS(TH)</sub>                      | $V_{GS} = V_{DS}, I_{D}$   | = 250 μA               | 1.2 |       | 2.1  | V     |
| Threshold Temperature Coefficient                            | V <sub>GS</sub> /T <sub>J</sub>          | I <sub>D</sub> = 250 μA, r   | ef to 25°C             |     | -4.76 |      | mV/°C |
| Drain-to-Source On Resistance                                | R <sub>DS(on)</sub>                      | V <sub>GS</sub> = 10 V,  | <sub>D</sub> = 10 A    |     | 3.35  | 4.1  | mΩ    |
|  |  | V <sub>GS</sub> = 4.5 V,   | I <sub>D</sub> = 10 A  |     | 5.02  | 6.25 | 1     |
| Forward Transconductance                                     | <b>g</b> fs                              | V <sub>DS</sub> = 5 V, I   | <sub>D</sub> = 10 A    |     | 47    |      | S     |
| Gate Resistance  | R <sub>G</sub>                           | T <sub>A</sub> = 25  | 5°C                    |     | 1     |      | Ω     |
| HARGES AND CAPACITANCES                                      |  |  |                        |     |       |      |       |
| Input Capacitance  | C <sub>iss</sub>                         | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 15 V,<br>f = 1.0 MHz  |                        |     | 851   |      | pF    |
| Output Capacitance   | C <sub>oss</sub>                         |  |                        |     | 524   |      |       |
| Reverse Transfer Capacitance                                 | C <sub>rss</sub>                         |  |                        |     | 35    |      | 1     |
| Total Gate Charge  | Q <sub>G(TOT)</sub>                      | V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V,<br>I <sub>D</sub> = 10 A  |                        |     | 6.7   |      | nC    |
| Threshold Gate Charge  | Q <sub>G(TH)</sub>                       |  |                        |     | 1.2   |      | nC    |
| Gate-to-Source Charge  | Q <sub>GS</sub>                          |  |                        |     | 2.3   |      | 1     |
| Gate-to-Drain Charge   | Q <sub>GD</sub>                          |  |                        |     | 2.2   |      |       |
| Total Gate Charge  | Q <sub>G(TOT)</sub>                      | $V_{GS}$ = 10 V, $V_{DS}$ = 15 V,<br>I <sub>D</sub> = 10 A   |                        |     | 14    |      | nC    |
| SWITCHING CHARACTERISTICS, V                                 | GS = 4.5 V (Note                         | 5)   |                        |     |       |      |       |
| Turn-On Delay Time   | t <sub>d(on)</sub>                       |  |                        |     | 9.3   |      | ns    |
| Rise Time  | t <sub>r</sub>                           | V <sub>GS</sub> = 4.5 V, V   | ם = 15 V.              |     | 8     |      | 1     |
| Turn-Off Delay Time  | t <sub>d(off)</sub>                      | $I_{\rm D} = 10 \rm{A}, \rm{F}$  | $_{\rm G} = 6 \Omega$  |     | 15    |      | 1     |
| Fall Time  | t <sub>f</sub>                           |  |                        |     | 7.7   |      | 1     |
| SWITCHING CHARACTERISTICS, V                                 |  | 5)   |                        |     | •     |      |       |
| Turn-On Delay Time   | t <sub>d(on)</sub>                       |  |                        |     | 6.8   |      | ns    |
| Rise Time  | t <sub>r</sub>                           | $V_{CR} = 10 V V$  | = 15 V                 |     | 2.7   |      | 1     |
| Turn-Off Delay Time  | t <sub>d(off)</sub>                      | $\begin{array}{l} V_{GS} = 10 \; V, \; V_{DD} = 15 \; V, \\ I_{D} = 10 \; A, \; R_{G} = 6 \; \Omega \end{array}$ |                        |     | 19.6  |      | 1     |
| Fall Time  | t <sub>f</sub>                           |  |                        |     | 4.8   |      | 1     |
| RAIN-SOURCE DIODE CHARACTE                                   | RISTICS                                  |  |                        |     |       |      | •     |
| Forward Diode Voltage  | V <sub>SD</sub> V <sub>CD</sub>          | V <sub>GS</sub> = 0 V,   | $T_J = 25^{\circ}C$    |     | 0.79  | 1.2  | 2 V   |
|  |  | $V_{GS} = 0.0,$<br>$I_{S} = 10 \text{ A}$  | T <sub>J</sub> = 125°C |     | 0.65  |      | 1     |
| Reverse Recovery Time  | t <sub>RR</sub>                          | $V_{OO} = 0 V dl_{0}/d$  | t = 100 A/us           |     | 32.6  |      | ns    |
| Reverse Recovery Charge                                      | Q <sub>RR</sub>                          | $V_{GS}$ = 0 V, dl <sub>S</sub> /dt = 100 A/µs,<br>I <sub>S</sub> = 10 A   |                        |     | 14.3  |      | nC    |

performance may not be indicated by the Electrical Characteristics for the listed test conditions. 4. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%. 5. Switching characteristics are independent of operating junction temperatures.

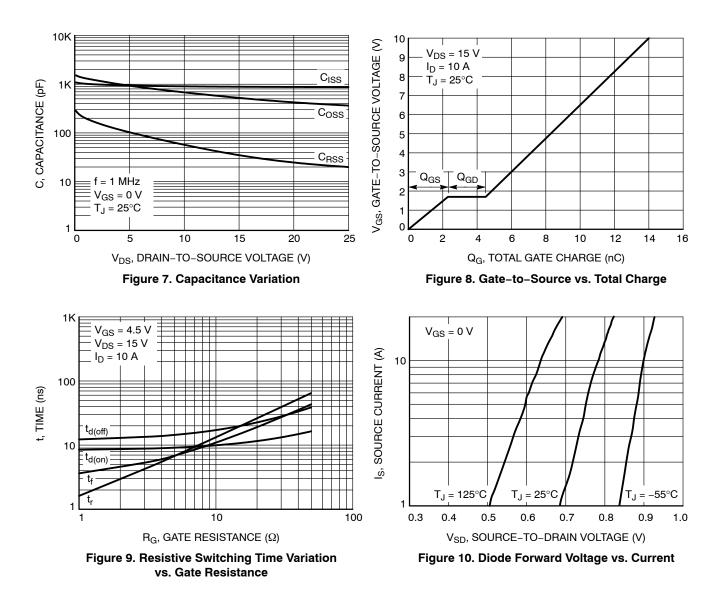
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## **TYPICAL CHARACTERISTICS**



## NTLJS4D7N03H

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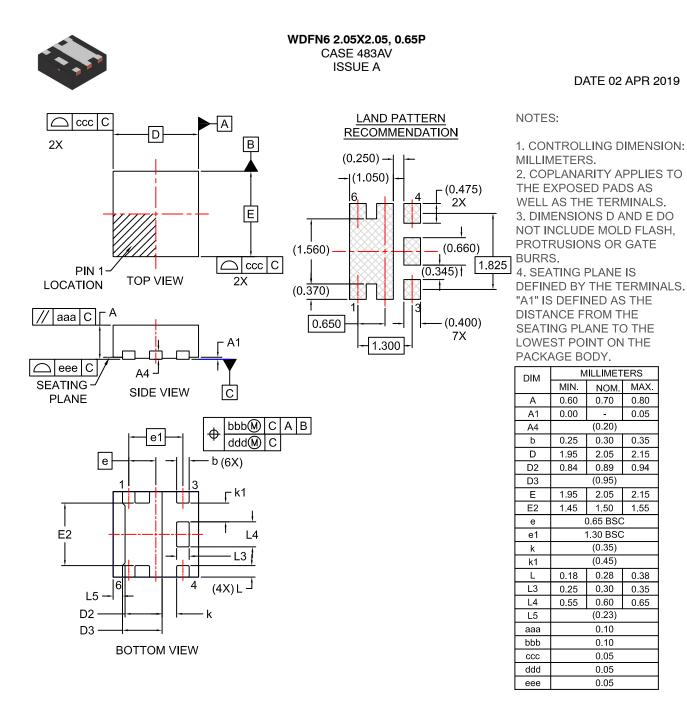


#### **DEVICE ORDERING INFORMATION**

| Device          | Package            | Shipping <sup>†</sup> |
|-----------------|--------------------|-----------------------|
| NTLJS4D7N03HTAG | WDFN6<br>(Pb–Free) | 3000 / Tape & Reel    |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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